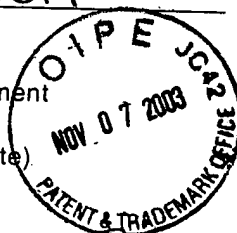


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- ☐ Assignment and Cover Sheet
- ☐ Information Disclosure Statement
- ☐ Response/Amendment
- ☐ Extension of Time (In Duplicate)
- ☐ Small Entity Status
- ☐ Copy of Priority Document
- ☒ Preliminary Amendment B



RE: APPLICATION ATTY/SEC: MJM/smw

File no: 0553-0166.01

Applicant: Yamazaki et al

S.N.: 10/629069 Filing Date: July 29, 2003

Wiring Material And A Semiconductor Device

Title: HAVING A WIRING USING THE MATERIAL AND

THE MANUFACTURING METHOD THEREOF

Due date: \_\_\_\_\_ Date Sent: 11/4/03

SEL

0553-0166.01  
EDM/MJM

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Wiring Material And A Semiconductor Device

Title: Having A Wiring Using The Material And

The Manufacturing Method Thereof

Due date: \_\_\_\_\_ Date Sent: 11/4/03

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Attorney Docket 0553-0166.01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of )  
)  
Yamazaki et al. )  
)  
Serial No.: 10/629,069 )  
)  
Filed: July 29, 2003 )  
)  
For: Wiring Material And A )  
Semiconductor Device Having A )  
Wiring Using the Material, And The )  
Manufacturing Method Thereof )  
)  
Art Unit: 2811 )  
)  
Examiner: )

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:  
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Shannon Wallace

Name of applicant, assignee, or Registered Rep.

Shannon Wallace 11/4/03

Signature

Date

Commissioner for Patents  
P.O. Box 1450  
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**PRELIMINARY AMENDMENT B**

Sir:

Prior to examination and calculation of the fees, please amend the above-identified application as follows: